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#### STD96N3LLH6

#### N-channel 30 V, 0.0037 Ω 80 A, DPAK STripFET™ VI DeepGATE™ Power MOSFET

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STD96N3LLH6	30 V	$0.0042~\Omega$	80 A

- R<sub>DS(on)</sub> \* Q<sub>g</sub> industry benchmark
- Extremely low on-resistance R<sub>DS(on)</sub>
- High avalanche ruggedness
- Low gate drive power losses

#### **Application**

- Switching applications
  - Automotive



This product is an N-channel Power MOSFET that utilizes the 6<sup>th</sup> generation of design rules of ST's proprietary STripFET<sup>TM</sup> technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest  $R_{DS(on)}$  in all packages.

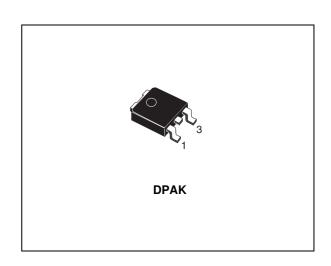


Figure 1. Internal schematic diagram

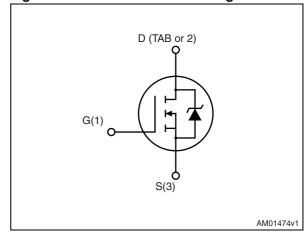


Table 1. Device summary

Order codes	Marking	Package	Packaging
STD96N3LLH6	96N3LLH6	DPAK	Tape and reel

Contents STD96N3LLH6

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STD96N3LLH6 Electrical ratings

## 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	30	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	80	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	61	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	320	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	70	W
	Derating factor	0.47	W/°C
E <sub>AS</sub> (3)	Single pulse avalanche energy	150	mJ
T <sub>stg</sub>	Storage temperature	-55 to 175	°C
T <sub>j</sub>	Max. operating junction temperature	175	°C

<sup>1.</sup> Limited by wire bonding.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	2.14	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	100	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb max	35	°C/W
T <sub>I</sub>	Maximum lead temperature for soldering purpose	275	°C

<sup>1.</sup> When mounted on FR-4 board of 1 inch<sup>2</sup>, 2 oz Cu.

<sup>2.</sup> Pulse width limited by safe operating area.

<sup>3.</sup> Starting Tj =  $25^{\circ}$ C,  $I_{AV} = 55$  A, L = 0.1 mH

Electrical characteristics STD96N3LLH6

## 2 Electrical characteristics

 $(T_{CASE} = 25 \, ^{\circ}C \text{ unless otherwise specified})$ 

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown Voltage	$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0$	30			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 30 V V <sub>DS</sub> = 30 V, Tc = 125 °C			1 10	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2.5	٧
D	Static drain-source on	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 40 A		0.0037	0.0042	Ω
R <sub>DS(on)</sub>	resistance	V <sub>GS</sub> = 5.5 V, I <sub>D</sub> = 40 A		0.0055	0.007	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions		Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25 \text{ V, f=1 MHz,} $ $V_{GS} = 0$	-	2200 400 280	-	pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 15 \text{ V}, I_{D} = 80 \text{ A}$ $V_{GS} = 4.5 \text{ V}$ Figure 13	-	20 8.2 7.5	-	nC nC nC
Q <sub>gs1</sub>	Pre V <sub>th</sub> gate-to-source charge Post V <sub>th</sub> gate-to-source charge	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 80 A Figure 18	-	3.4 6.2	-	nC nC
R <sub>G</sub>	Gate input resistance	f = 1 MHz gate bias Bias = 0 test signal level = 20 mV open drain	-	1	-	Ω

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time Rise time	$V_{DD} = 15 \text{ V}, I_{D} = 40 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GS} = 5 \text{ V}$ Figure 12	-	19 91	-	ns ns
t <sub>d(off)</sub>	Turn-off delay time Fall time	$V_{DD} = 15 \text{ V}, I_{D} = 40 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GS} = 5 \text{ V}$ Figure 12	-	24.5 23.4	-	ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)		-		80 320	A A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 40 A, V <sub>GS</sub> = 0	-		1.1	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 80 \text{ A},$ di/dt = 100 A/ $\mu$ s, $V_{DD} = 24 \text{ V}$ Figure 14	-	28.6 22.8 1.6		ns nC A

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

Electrical characteristics STD96N3LLH6

#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

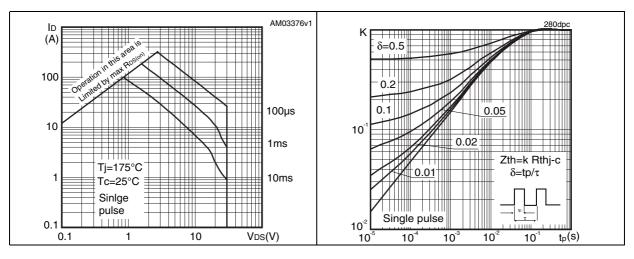


Figure 4. Output characteristics

Figure 5. Transfer characteristics

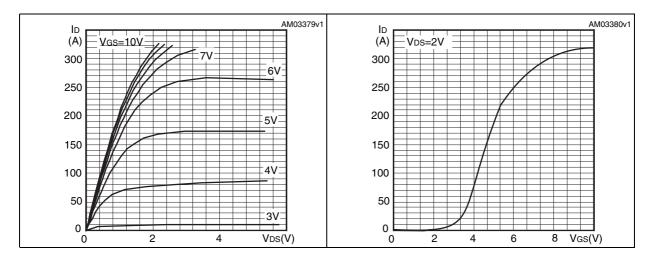
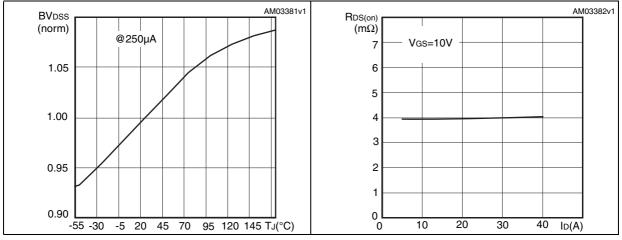


Figure 6. Normalized BV<sub>DSS</sub> vs temperature Figure 7. Static drain source on resistance



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Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

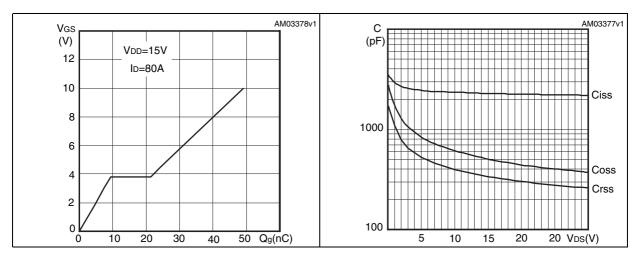
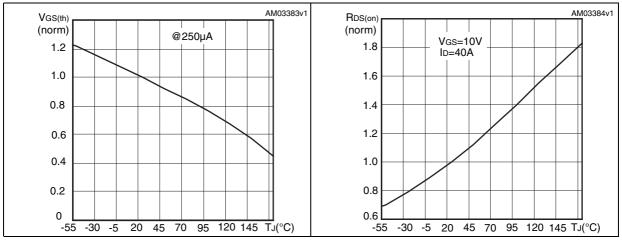


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature



Test circuits STD96N3LLH6

#### 3 Test circuits

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

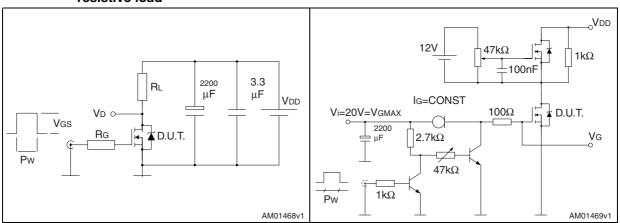


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped inductive load test circuit

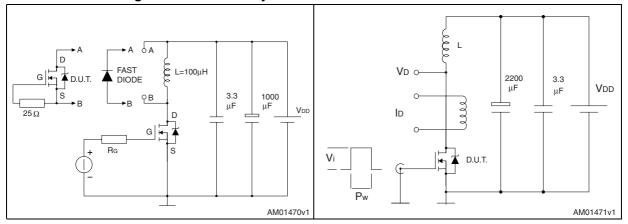
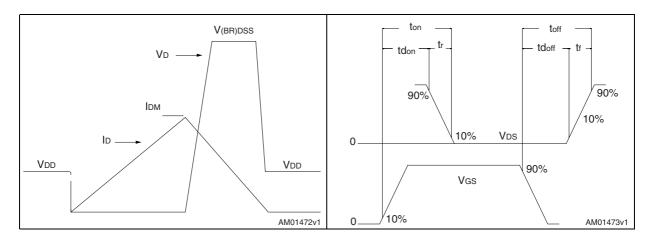


Figure 16. Unclamped inductive waveform

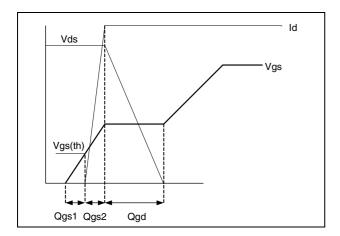
Figure 17. Switching time waveform



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STD96N3LLH6 Test circuits

Figure 18. Gate charge waveform



#### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 8. DPAK (TO-252) mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
А	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
е		2.28	
e1	4.40		4.60
Н	9.35		10.10
L	1		
L1		2.80	
L2		0.80	
L4	0.60		1
R		0.20	
V2	0°		8°

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THERMAL PAD

E1

D1

R

GAUGE PLANE

1

O068772\_G

O068772\_G

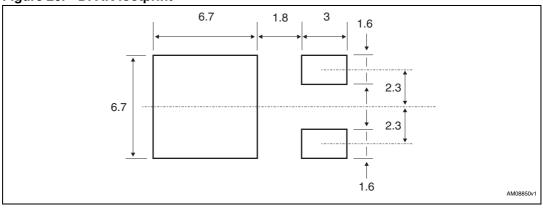
Figure 19. DPAK (TO-252) drawing

## 5 Packaging mechanical data

Table 9. DPAK (TO-252) tape and reel mechanical data

	Таре			Reel	
Dim.	mm		Dim.	1	mm
Dilli.	Min.	Max.		Min.	Max.
A0	6.8	7	Α		330
B0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
Е	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1		Base qty.	2500
P1	7.9	8.1		Bulk qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

Figure 20. DPAK footprint<sup>(a)</sup>



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a. All dimension are in millimeters

Figure 21. Tape for DPAK (TO-252)

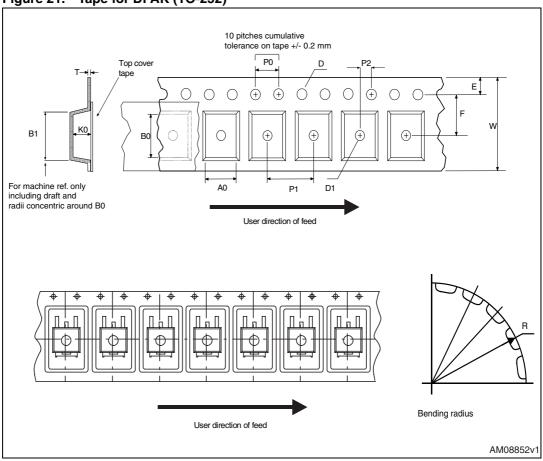
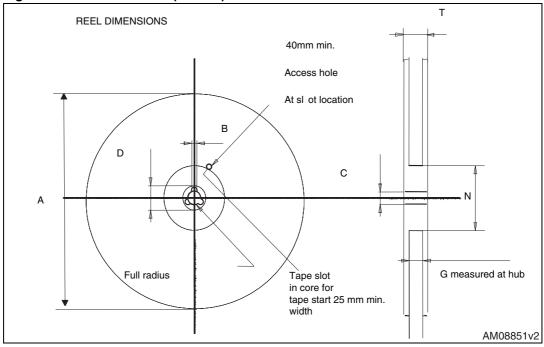


Figure 22. Reel for DPAK (TO-252)



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Revision history STD96N3LLH6

# 6 Revision history

Table 10. Document revision history

Date	Revision	Changes
27-Jan-2011	1	First release.

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